

# **DMP3098L**

# P-Channel Enhancement Mode MOSFET

#### **Feature**

•-30V/-3.8A,  $R_{DS(ON)} = 55 m\Omega(MAX)$  @VGS = -10V.

 $R_{DS(ON)} = 70 m\Omega(MAX)$  @ $V_{GS} = -4.5V$ .

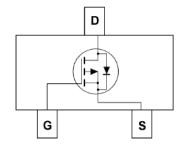
 $R_{DS(ON)}\!=\!120m\Omega(MAX)\ @V_{GS}\!=\text{-}2.5V.$ 

- •Super High dense cell design for extremely low RDS(ON)
- •Reliable and Rugged
- •SOT-23 for Surface Mount Package

# **Applications**

- Power Management
- •Portable Equipment and Battery Powered Systems.





# Absolute Maximum Ratings TA=25°C Unless Otherwise noted

Parameter	Symbol	Limit	Units	
Drain-Source Voltage	$V_{DS}$	-30	V	
Gate-Source Voltage	$V_{GS}$	±12	V	
Drain Current-Continuous	$I_D$	-3.8	A	

# Electrical Characteristics TA=25°C Unless Otherwise noted

Parameter Parameter	Symbol	Test Conditions	Min	Тур.	Max	Units
Off Characteristics			•			
Drain to Source Breakdown Voltage	BVDSS	VGS=0V, ID=-250μA	-30	-	-	V
Zero-Gate Voltage Drain Current	IDSS	VDS=-24V, VGS=0V	-	-	-1	μΑ
Gate Body Leakage Current, Forward	IGSSF	VGS=12V, VDS=0V	-	-	100	nA
Gate Body Leakage Current, Reverse	IGSSR	VGS=-12V, VDS=0V	-	-	-100	nA
On Characteristics			•			•
Gate Threshold Voltage	VGS(th)	VGS= VDS, ID=-250μA	-0.7	-	-1.3	V
Static Drain-source On-Resistance RDS(O	RDS(ON)	VGS =-10V, ID =-4.2A	-	50	55	$m\Omega$
		VGS =-4.5V, ID =-4.0A	-	60	70	$m\Omega$
		VGS =-2.5V, ID =-1.0A	-	80	120	$m\Omega$
Drain-Source Diode Characteristi	cs and Maximum	Ratings		•		•
Drain-Source Diode Forward Voltage	VSD	VGS =0V, IS=-1.0A			-1.0	V

REV.08 1 of 2





# Typical Characteristics

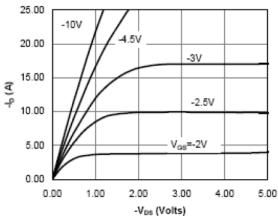


Fig 1: On-Region Characteristics

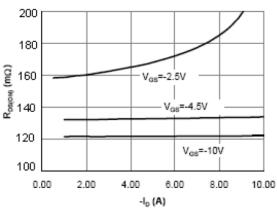


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

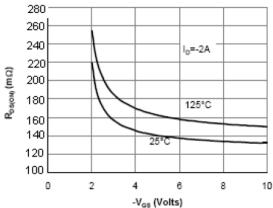


Figure 5: On-Resistance vs. Gate-Source Voltage

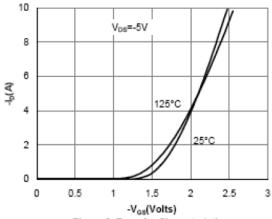
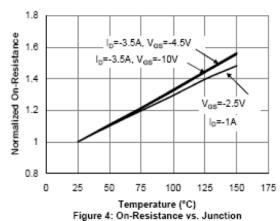


Figure 2: Transfer Characteristics



Temperature

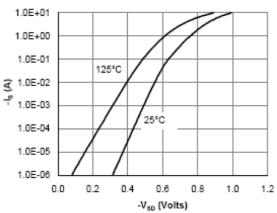


Figure 6: Body-Diode Characteristics